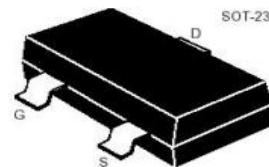
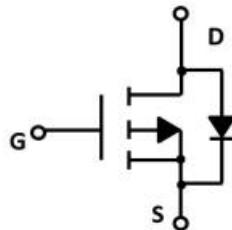


**SOT-23 -60V P Channel Enhancement 沟道增强型
MOS Field Effect Transistor 场效应管**

■ Absolute Maximum Ratings 最大额定值

| Characteristic 特性参数 | Symbol 符号 | Rating 额定值 | Unit 单位 |
|--|--------------------------------|------------|---------|
| Drain-Source Voltage 漏极-源极电压 | BV_{DSS} | -60 | V |
| Gate- Source Voltage 栅极-源极电压 | V_{GS} | ± 20 | V |
| Drain Current (continuous)漏极电流-连续 | I_D (at $T_A = 25^\circ C$) | -170 | mA |
| Drain Current (pulsed)漏极电流-脉冲 | I_{DM} | -1.2 | A |
| Total Device Dissipation 总耗散功率 | P_D (at $T_A = 25^\circ C$) | 225 | mW |
| Thermal Resistance Junction-Ambient 热阻 | $R_{\Theta JA}$ | 625 | °C/W |
| Junction/Storage Temperature 结温/储存温度 | T_J, T_{stg} | -55~150 | °C |

■ Device Marking 产品字标

BSS84=PD9

■ Electrical Characteristics 电特性(T_A=25°C unless otherwise noted 如无特殊说明, 温度为 25°C)

| Characteristic 特性参数 | Symbol 符号 | Min 最小值 | Typ 典型值 | Max 最大值 | Unit 单位 |
|--|---------------------|------------|------------|------------|------------|
| Drain-Source Breakdown Voltage 漏极-源极击穿电压(I _D = -250uA, V _{GS} =0V) | BV _{DSS} | -60 | — | — | V |
| Gate Threshold Voltage 栅极开启电压(I _D = -250uA, V _{GS} = V _{DS}) | V _{GS(th)} | -0.9 | -1.4 | -2 | V |
| Zero Gate Voltage Drain Current 零栅压漏极电流(V _{GS} =0V, V _{DS} = -60V) | I _{DSS} | — | — | 1 | uA |
| Gate Body Leakage 栅极漏电流(V _{GS} =±20V, V _{DS} =0V) | I _{GSS} | — | — | ±100 | nA |
| Static Drain-Source On-State Resistance 静态漏源导通电阻(I _D = -150mA, V _{GS} = -10V) (I _D = -150mA, V _{GS} = -4.5V) | R _{DS(ON)} | — | 3.3 3.5 | 8 10 | Ω |
| Diode Forward Voltage Drop 内附二极管正向压降 (I _{SD} = -170mA, V _{GS} =0V) | V _{SD} | — | — | -1.2 | V |
| Input Capacitance 输入电容 (V _{GS} =0V, V _{DS} = -30V,f=1MHz) | C _{ISS} | — | 43 | — | pF |
| Common Source Output Capacitance 共源输出电容(V _{GS} =0V, V _{DS} = -30V,f=1MHz) | C _{OSS} | — | 3 | — | pF |
| Reverse Transfer Capacitance 反馈电容(V _{GS} =0V, V _{DS} = -30V,f=1MHz) | C _{RSS} | — | 1.8 | — | pF |
| Total Gate Charge 棚极电荷密度 (V _{DS} = -30V, I _D = -150mA, V _{GS} =10V) | Q _g | — | 1.7 | — | nC |
| Gate Source Charge 棚源电荷密度 (V _{DS} = -30V, I _D = -150mA, V _{GS} =10V) | Q _{gs} | — | 0.57 | — | nC |
| Gate Drain Charge 棚漏电荷密度 (V _{DS} = -30V, I _D = -150mA, V _{GS} =10V) | Q _{gd} | — | 0.25 | — | nC |
| Turn-ON Delay Time 开启延迟时间 (V _{DS} =-30V I _D =-150mA, R _{GEN} =3 Ω ,V _{GS} =-10V) | t _{d(on)} | — | 9 | — | ns |
| Turn-ON Rise Time 开启上升时间 (V _{DS} =-30V I _D =-150mA, R _{GEN} =3 Ω ,V _{GS} =-10V) | t _r | — | 19 | — | ns |
| Turn-OFF Delay Time 关断延迟时间 (V _{DS} =-30V I _D =-150mA, R _{GEN} =3 Ω ,V _{GS} =-10V) | t _{d(off)} | — | 15 | — | ns |
| Turn-OFF Fall Time 关断下降时间 (V _{DS} =-30V I _D =-150mA, R _{GEN} =3 Ω ,V _{GS} =-10V) | t _f | — | 77 | — | ns |

■Typical Characteristic Curve 典型特性曲线

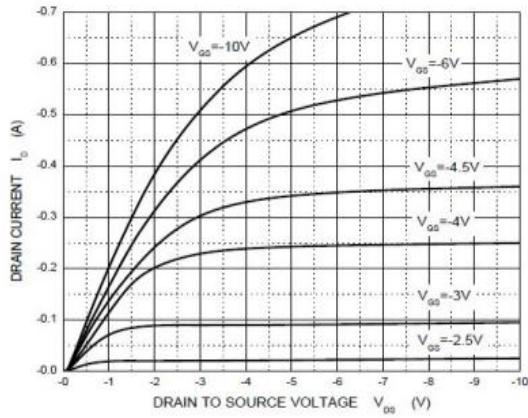


Figure 1: Output Characteristics

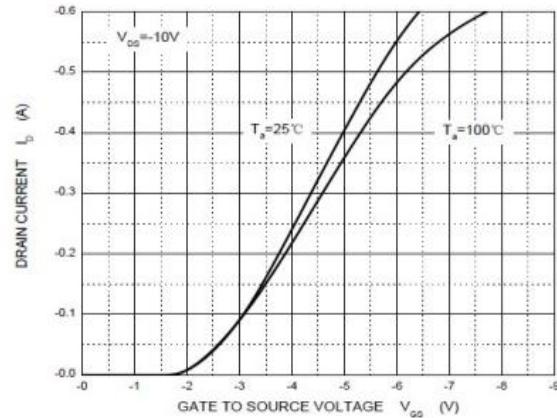


Figure 2: Transfer Characteristics

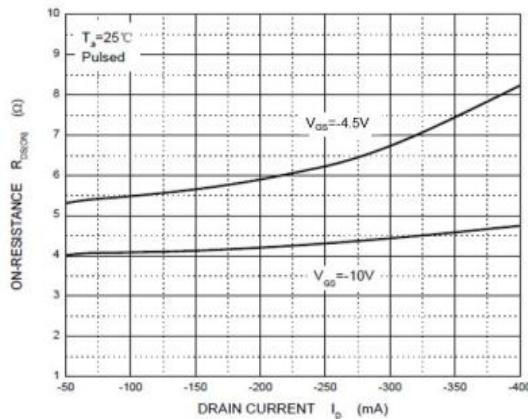


Figure 3: On-Resistance vs. Drain Current

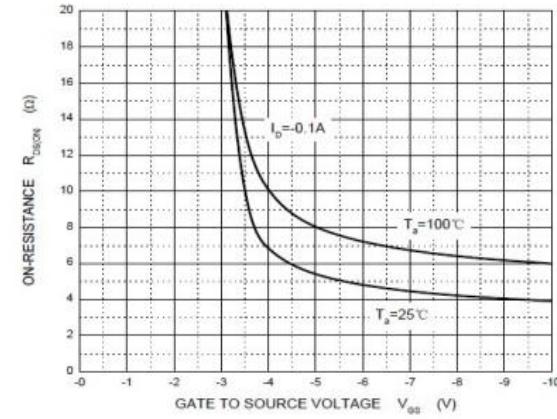


Figure 4: On-Resistance vs. V_{GS}

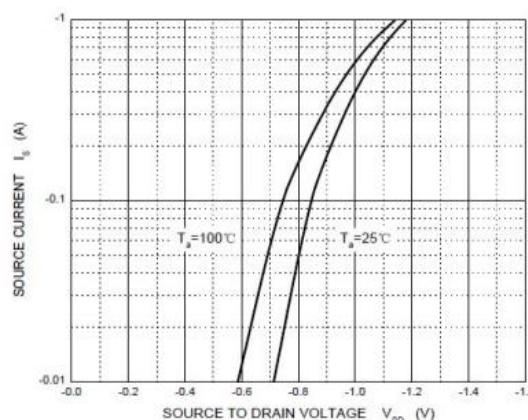


Figure 5: Diode Characteristics

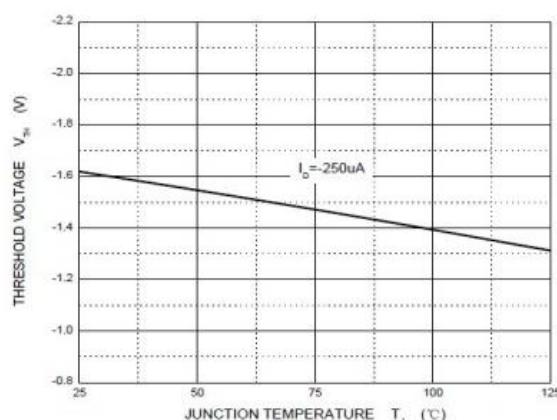
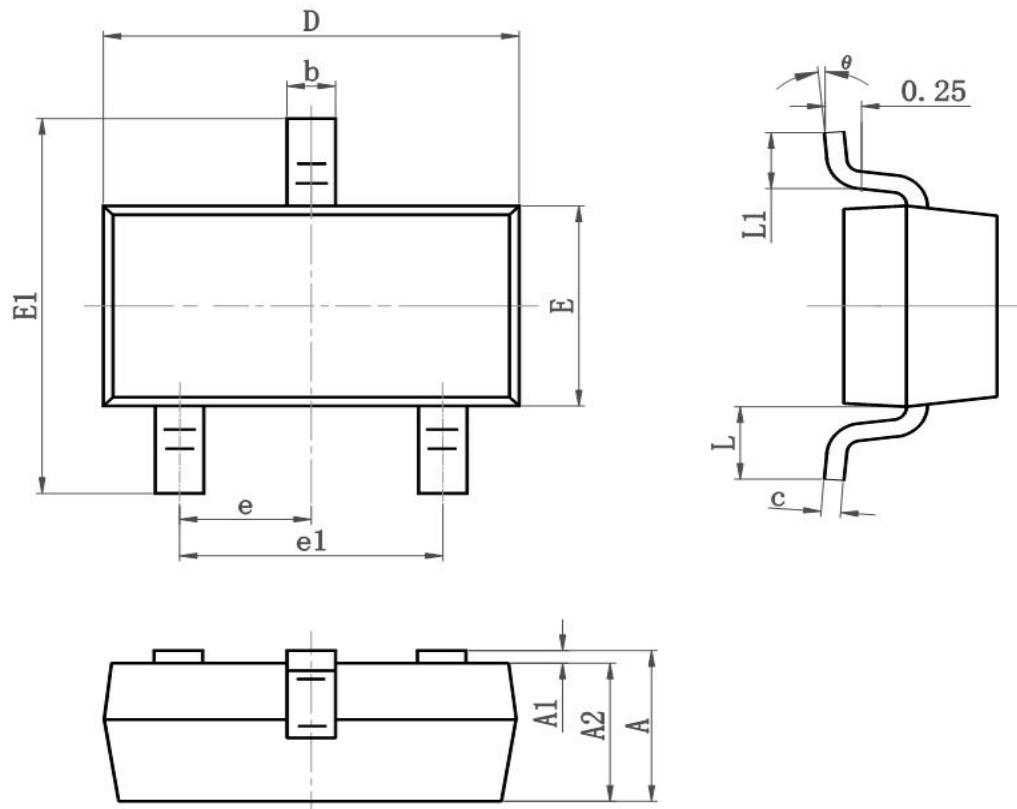


Figure 6: Threshold Voltage vs. T_J

■ Dimension 外形封装尺寸



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 0.900 | 1.150 | 0.035 | 0.045 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 0.900 | 1.050 | 0.035 | 0.041 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.080 | 0.150 | 0.003 | 0.006 |
| D | 2.800 | 3.000 | 0.110 | 0.118 |
| E | 1.200 | 1.400 | 0.050 | 0.055 |
| E1 | 2.250 | 2.550 | 0.089 | 0.100 |
| e | 0.900 | 1.00 | 0.035 | 0.039 |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.500 | 0.600 | 0.020 | 0.024 |
| L1 | 0.300 | 0.500 | 0.012 | 0.020 |
| θ | 0° | 8° | 0° | 8° |